Quad single-pole single-throw analog switch Rev. 7 — 16 November 2011

Product data sheet

1. **General description**

The HEF4066B provides four single-pole, single-throw analog switch functions. Each switch has two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When nE is LOW, the analog switch is turned off.

The HEF4066B is pin compatible with the HEF4016B but exhibits a much lower ON resistance. In addition the ON resistance is relatively constant over the full input signal range.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Inputs and outputs are protected against electrostatic effects
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

Ordering information 4.

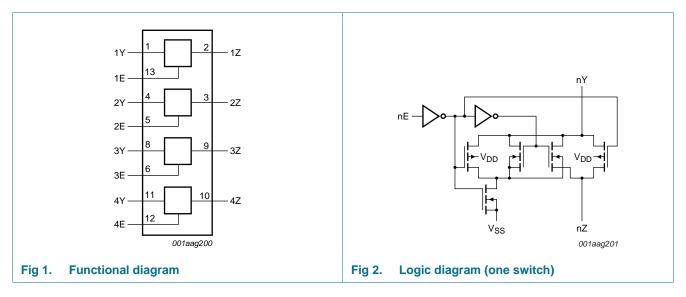
Table 1. **Ordering information**

| Type number | Package | | | | | | | |
|-------------|-------------------|-------|---|----------|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | |
| HEF4066BP | –40 °C to +125 °C | DIP14 | plastic dual in-line package; 14 leads (300 mil) | SOT27-1 | | | | |
| HEF4066BT | –40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 | | | | |



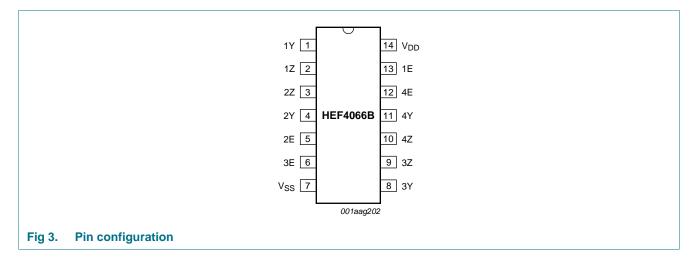
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5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

| Table 2.Pin description | | |
|-------------------------|--------------|-----------------------------|
| Symbol | Pin | Description |
| 1Y, 2Y, 3Y, 4Y | 1, 4, 8, 11 | independent input or output |
| 1Z, 2Z, 3Z, 4Z | 2, 3, 9, 10 | independent input or output |
| 1E, 2E, 3E, 4E | 13, 5, 6, 12 | enable input (active HIGH) |
| V _{SS} | 7 | ground (0 V) |
| V _{DD} | 14 | supply voltage |

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7. Functional description

| Input nE Switch H ON L OFF | Table 3. | Function table ^[1] | |
|--|----------|-------------------------------|--------|
| | Input nE | | Switch |
| L OFF | Н | | ON |
| | L | | OFF |

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0 V$ (ground).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|--------------|----------------|------|
| V_{DD} | supply voltage | | -0.5 | +18 | V |
| I _{IK} | input clamping current | $V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm DD}$ + 0.5 V | - | ±10 | mA |
| VI | input voltage | | -0.5 | V_{DD} + 0.5 | V |
| I _{I/O} | input/output current | | <u>[1]</u> _ | ±10 | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| T _{amb} | ambient temperature | | -40 | +85 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to +85 \ ^{\circ}C$ | | | |
| | | DIP14 | [2] _ | 750 | mW |
| | | SO14 | [3] _ | 500 | mW |
| Р | power dissipation | per switch | - | 100 | mW |

[1] To avoid drawing V_{DD} current out of terminal nZ, when switch current flows into terminals nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no V_{DD} current will flow out of terminals nY, in this case there is no limit for the voltage drop across the switch, but the voltages at nY and nZ may not exceed V_{DD} or V_{SS}.

[2] For DIP14 packages: above T_{amb} = 70 °C, P_{tot} derates linearly with 12 mW/K.

[3] For SO14 packages: above $T_{amb} = 70 \text{ °C}$, P_{tot} derates linearly with 8 mW/K.

9. Recommended operating conditions

| Table 5. | Recommended operating con | | | | | |
|-----------------------|-------------------------------------|------------------------|-----|-----|----------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V_{DD} | supply voltage | | 3 | - | 15 | V |
| VI | input voltage | | 0 | - | V_{DD} | V |
| T _{amb} | ambient temperature | in free air | -40 | - | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | $V_{DD} = 5 V$ | - | - | 3.75 | μs/V |
| | | V _{DD} = 10 V | - | - | 0.5 | μs/V |
| | | V _{DD} = 15 V | - | - | 0.08 | μs/V |

Table 5. Recommended operating conditions

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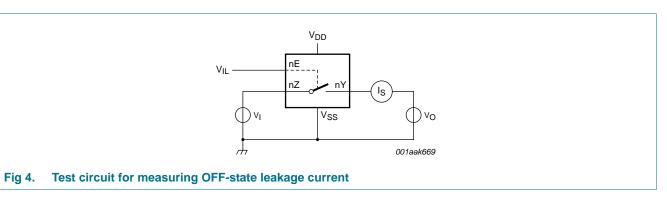
10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_{I} = V_{SS}$ or V_{DD} unless otherwise specified.

| Symbol | Parameter | Conditions | V _{DD} | T _{amb} = | −40 °C | T _{amb} = | = 25 °C | T _{amb} = | = 85 °C | T _{amb} = | 125 °C | Unit |
|-----------------|---------------------------------|-------------------------------------|-----------------|--------------------|---------------|--------------------|---------|--------------------|---------|--------------------|--------|------|
| | | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| V _{IH} | HIGH-level | I _O < 1 μA | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | 3.5 | - | V |
| | input voltage | | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | 7.0 | - | V |
| | | | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | 11.0 | - | V |
| V _{IL} | LOW-level | $ I_0 < 1 \ \mu A$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | - | 1.5 | V |
| | input voltage | oltage | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | - | 3.0 | V |
| | | | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | - | 4.0 | V |
| lı | input leakage current | | 15 V | - | ±0.1 | - | ±0.1 | - | ±1.0 | - | ±1.0 | μΑ |
| $I_{S(OFF)}$ | OFF-state leakage current | per channel; see <u>Figure 4</u> | 15 V | - | - | - | 200 | - | - | - | - | nA |
| I _{DD} | supply current | | 5 V | - | 1.0 | - | 1.0 | - | 7.5 | - | 7.5 | μA |
| | | combinations | 10 V | - | 2.0 | - | 2.0 | - | 15.0 | - | 15.0 | μA |
| | | | 15 V | - | 4.0 | - | 4.0 | - | 30.0 | - | 30.0 | μΑ |
| CI | input capacitance | nE input | - | - | - | - | 7.5 | - | - | - | - | pF |

10.1 Test circuit



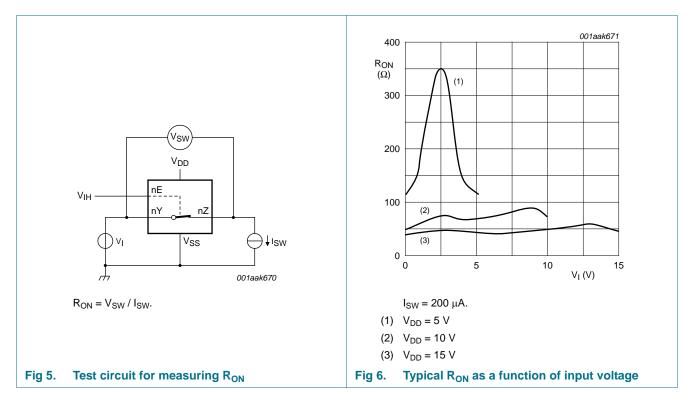
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10.2 ON resistance

Table 7. ON resistance

| Symbol | Parameter | Conditions | V _{DD} | Тур | Max | Unit |
|-----------------------|------------------------|--|-----------------|-----|------|------|
| R _{ON(peak)} | ON resistance (peak) | $V_I = 0 V$ to V_{DD} ; see Figure 5 and | 5 V | 350 | 2500 | Ω |
| | | Figure 6 | 10 V | 80 | 245 | Ω |
| | | | 15 V | 60 | 175 | Ω |
| R _{ON(rail)} | ON resistance (rail) | $V_I = 0 V$; see <u>Figure 5</u> and <u>Figure 6</u> | 5 V | 115 | 340 | Ω |
| | | | 10 V | 50 | 160 | Ω |
| | | | 15 V | 40 | 115 | Ω |
| | | $V_I = V_{DD}$; see <u>Figure 5</u> and <u>Figure 6</u> | 5 V | 120 | 365 | Ω |
| | | | 10 V | 65 | 200 | Ω |
| | | | 15 V | 50 | 155 | Ω |
| ΔR_{ON} | ON resistance mismatch | $V_I = 0 V$ to V_{DD} ; see <u>Figure 5</u> | 5 V | 25 | - | Ω |
| | between channels | | 10 V | 10 | - | Ω |
| | | | 15 V | 5 | - | Ω |

10.2.1 ON resistance waveform and test circuit



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11. Dynamic characteristics

| Table 8. T _{amb} = 25 | Dynamic characteristics $^{\circ}C; V_{SS} = 0 V;$ for test circuit see <u>F</u> | - igure <u>9</u> . | | | | |
|--|--|---------------------------------------|-----------------|-----|-----|------|
| Symbol | Parameter | Conditions | V _{DD} | Тур | Мах | Unit |
| t _{PHL} | HIGH to LOW propagation delay | nY, nZ to nZ, nY; see <u>Figure 7</u> | 5 V | 10 | 20 | ns |
| | | | 10 V | 5 | 10 | ns |
| | | | 15 V | 5 | 10 | ns |
| | | nY, nZ to nZ, nY; see Figure 7 | 5 V | 10 | 20 | ns |
| | | | 10 V | 5 | 10 | ns |
| | | | 15 V | 5 | 10 | ns |
| 1112 | HIGH to OFF-state propagation delay | nE to nY, nZ; see <u>Figure 8</u> | 5 V | 80 | 160 | ns |
| | | | 10 V | 65 | 130 | ns |
| | | | 15 V | 60 | 120 | ns |
| t _{PZH} | OFF-state to HIGH propagation delay | nE to nY, nZ; see <u>Figure 8</u> | 5 V | 40 | 80 | ns |
| | | | 10 V | 20 | 40 | ns |
| | | | 15 V | 15 | 30 | ns |
| t _{PLZ} | LOW to OFF-state | nE to nY, nZ; see <u>Figure 8</u> | 5 V | 80 | 160 | ns |
| | propagation delay | | 10 V | 70 | 140 | ns |
| | | | 15 V | 70 | 140 | ns |
| t _{PZL} | OFF-state to LOW | nE to nY, nZ; see Figure 8 | 5 V | 45 | 90 | ns |
| | propagation delay | | 10 V | 20 | 40 | ns |
| | | | 15 V | 15 | 30 | ns |

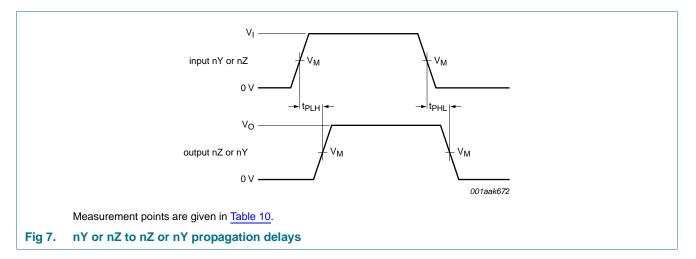
Table 9. Dynamic power dissipation P_D

 P_D can be calculated from the formulas shown; $V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

| D | | | | |
|---|-------------|--|---|--|
| Symbol | Parameter | V _{DD} | Typical formula for P_D (μ W) | where: |
| P _D dynamic power dissipation | 5 V | $P_D = 2500 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$ | f_i = input frequency in MHz; | |
| | dissipation | 10 V | $P_D = 11500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$ | f_o = output frequency in MHz; |
| | | 15 V | $P_D = 29000 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$ | C_L = output load capacitance in pF; |
| | | | | V _{DD} = supply voltage in V; |
| | | | | $\Sigma(C_L \times f_o)$ = sum of the outputs. |

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11.1 Waveforms and test circuit



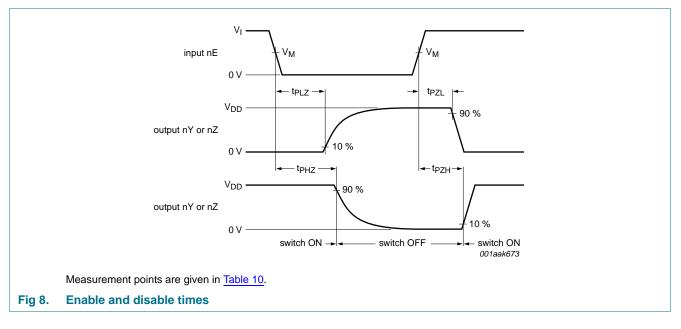


Table 10.Measurement points

| Supply voltage | Input | Output |
|-----------------|--------------------|--------------------|
| V _{DD} | V _M | V _M |
| 5 V to 15 V | 0.5V _{DD} | 0.5V _{DD} |

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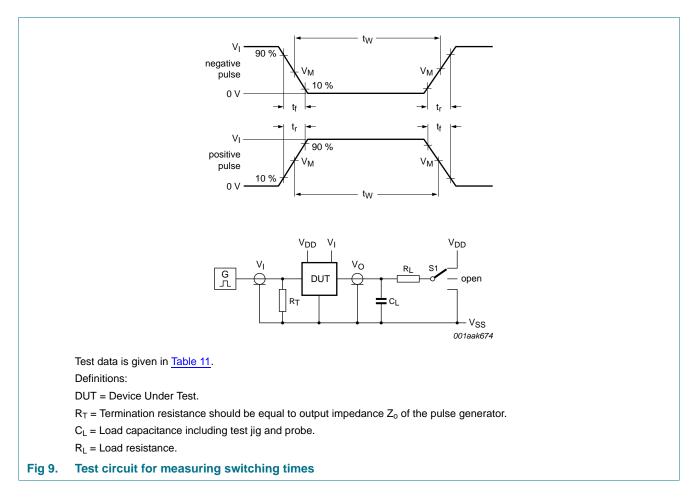


Table 11. Test data

| Supply voltage | Input | | Load | | S1 position | | | |
|-----------------|-----------------|---------------------------------|-------|-------|-------------------------------------|-------------------------------------|-------------------------------------|--|
| V _{DD} | VI | t _r , t _f | CL | RL | t _{PHL} , t _{PLH} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} | |
| 5 V to 15 V | 0 V or V_{DD} | \leq 20 ns | 50 pF | 10 kΩ | V _{SS} | V _{SS} | V _{DD} | |

11.2 Additional dynamic parameters

Table 12. Additional dynamic characteristics °C.

| $V_{\rm SS} = 0$ | V; | T _{amb} | = 25 |
|------------------|----|------------------|------|
|------------------|----|------------------|------|

| Symbol | Parameter | Conditions | V_{DD} | Тур | Max | Unit |
|-------------------------------|--|---|-----------------|-----------------|-----|------|
| THD total harmonic distortion | total harmonic distortion | see Figure 10; $R_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; | 5 V | <u>[1]</u> 0.25 | - | % |
| | channel ON; V _I = 0.5V _{DD} (p-p); f _i = 1 kHz | 10 V | <u>[1]</u> 0.04 | - | % | |
| | | | 15 V | <u>[1]</u> 0.04 | - | % |
| V _{ct} | crosstalk voltage | nE input to switch; see Figure 11; $R_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; $nE = V_{DD}$ (square-wave) | 10 V | 50 | - | mV |

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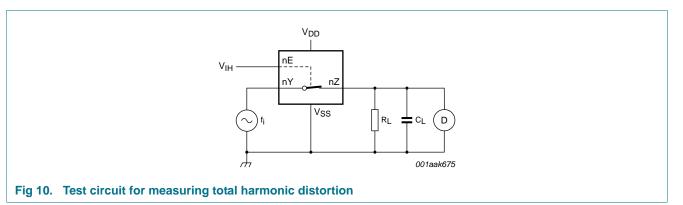
Table 12. Additional dynamic characteristics ...continued

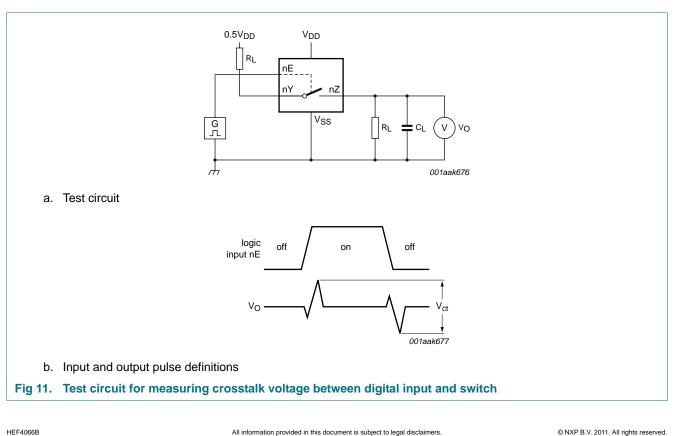
$V_{SS} = 0$ V; $T_{amb} = 25$ °C.

| Symbol | Parameter | Conditions | V _{DD} | Тур | Мах | Unit |
|---------------------|--------------------------|---|-----------------|----------------|-----|------|
| Xtalk | crosstalk | between switches; see Figure 12; $f_i = 1 \text{ MHz}$; $R_L = 1 \text{ k}\Omega$; $V_I = 0.5V_{DD} \text{ (p-p)}$ | 10 V | <u>[1]</u> –50 | - | dB |
| α_{iso} | isolation (OFF-state) | see Figure 13; $f_i = 1 \text{ MHz}$; $R_L = 1 \text{ k}\Omega$; $C_L = 5 \text{ pF}$; $V_I = 0.5 V_{DD} \text{ (p-p)}$ | 10 V | <u>[1]</u> –50 | - | dB |
| f _(-3dB) | -3 dB frequency response | see Figure 14; $R_L = 1 \text{ k}\Omega$; $C_L = 5 \text{ pF}$; $V_I = 0.5V_{DD}$ (p-p) | 10 V | <u>[1]</u> 90 | - | MHz |

[1] f_i is biased at 0.5V_{DD}.

11.2.1 Test circuits



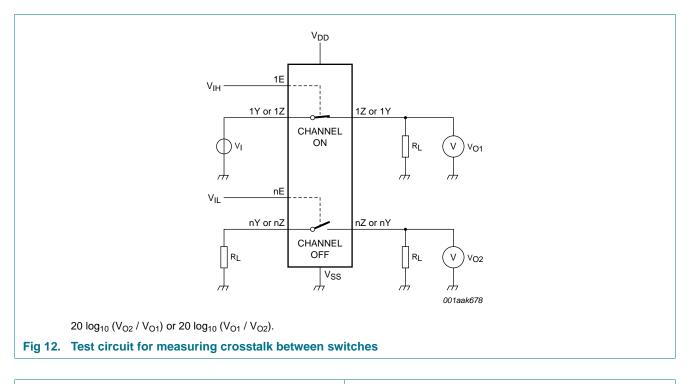


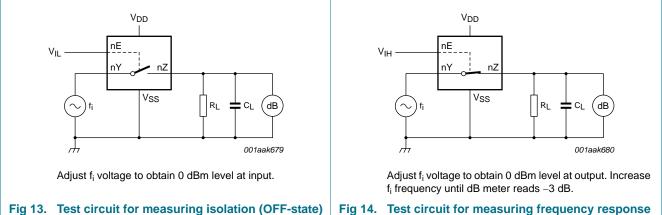
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12. Package outline

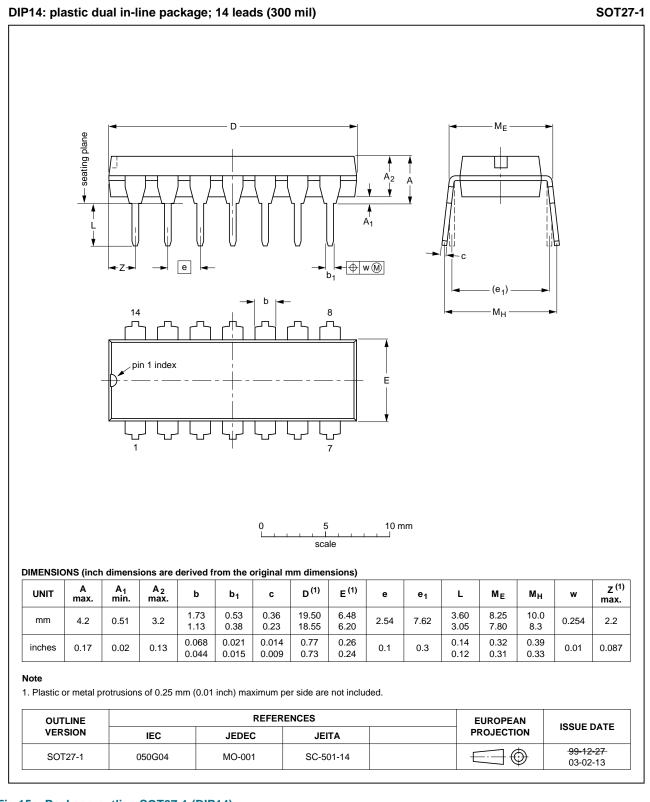


Fig 15. Package outline SOT27-1 (DIP14)

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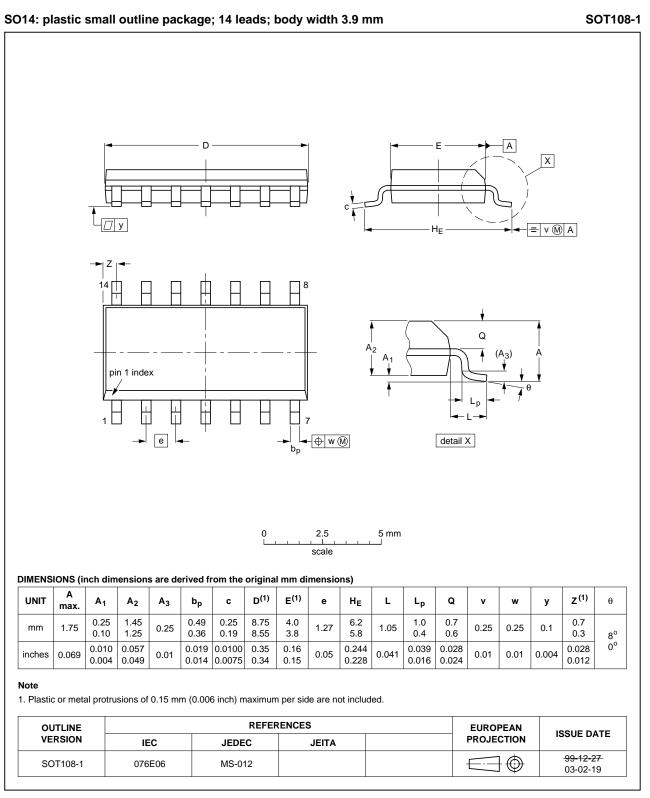


Fig 16. Package outline SOT108-1 (SO14)

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13. Revision history

| Table 13. Revision hi | story | | | |
|-----------------------|---------------------------------|------------------------------|------------------------|------------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| HEF4066B v.7 | 20111116 | Product data sheet | - | HEF4066B v.6 |
| Modifications: | Legal pages | s updated. | | |
| | Changes in | "General description", "Feat | ures and benefits" and | "Applications". |
| HEF4066B v.6 | 20100325 | Product data sheet | - | HEF4066B v.5 |
| HEF4066B v.5 | 20100225 | Product data sheet | - | HEF4066B v.4 |
| HEF4066B v.4 | 20091013 | Product data sheet | - | HEF4066B_CNV v.3 |
| HEF4066B_CNV v.3 | 19950101 | Product specification | - | HEF4066B_CNV v.2 |
| HEF4066B_CNV v.2 | 19950101 | Product specification | - | - |
| | | | | |

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|--------------------------------|-------------------------------|---|
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